

Typical Specifications

improved and flexible design of the set mechanism

Ite	ms	Specifications		
Rating (max.)/(mi (Resistive load)	n.)	0.1A 12V DC / 50μA 3V DC		
Contact resistance (Initial / After operating life)		100m Ω max. / 300m Ω max.		
Operating force		0.7N max.		
Operating life	Without load	50,000cycles		
Operating life	With load	50,000cycles (0.1A 12V DC)		

Product Line

		Changeover	Terminal type	Mounting method	Minimum order unit (pcs)		Product No.	Drawing No.
		timing	Tommar type	Wounting metriod	Japan	Export	T TOUGOT TWO.	Didwing No.
			For PC board	PC board		3,000	SSCF110100	1
1 2	2 Non shorting	FOI PC boald	- Screw PC board with hook	600 3,000	SSCF210100		2	
		For Lead			SSCF210300	3		
		For PC board				SSCF310100	4	

Packing Specifications

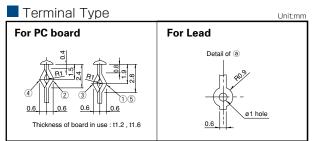
Bulk

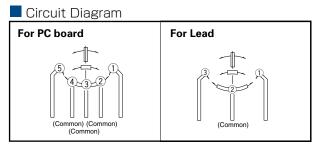
Number of pa	Export package measurements (mm)	
1 case /Japan 1 case /export packing		
600	3,000	400×270×290

Dim	nensions		Unit:mm_
No.	Photo	Style	PC board mounting hole dimensions
1	For PC board	Travel ON OFF 36* 18* (27) (7) (7) (7) (2) (2) (2) (2) (2) (2) (2) (2) (2) (2	P2.5 5-ø0.9 hole

Dimensions

Unit:mm No. Photo Style For PC board (Screw mounting) OFF 2 Terminal No.① For Lead (Screw mounting) 3 PC board mounting face 0.83 Terminal No.1 For PC board PC board mounting hole OFF (With hook) dimensions (7) (7) PC board mounting face





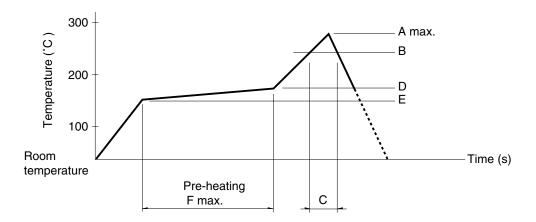
Series		General-purpose Type					
	DELIES -	SSCT	SSCF	sscw	SSCL		
Photo							
Opera	ation type	Two-way					
	W	12.5	11	13.1	11		
Dimensio (mm)	ns D	5	5.8	11.35	16.1		
	Н	11.5	12.4	5	.3		
Operating to	emperature range		-40℃ t	o +85℃			
Autor	notive use	•	•	•	•		
Life cycle	e (availability)	*3	* 3	**3	★13		
Poles / Positions		1/2		1/1	1/2		
Rating (max.) (Resistive load)		0.1A 12V DC					
	ng (min.) stive load)	50μA 3V DC		100μA 3V DC	50μA 5V DC		
	Operating life without load	$10,000$ cycles 500 m Ω max.	50,000cycles 300mΩ max.	100,000cycles 1Ω max.	50,000cycles 1Ω max.		
Durability	Operating life with load Rating (max.) (Resistive load)	10,000cycles 500mΩ max.	50,000cycles 300mΩ max.	100,000cycles 1Ω max.	50,000cycles 1Ω max.		
	Initial contact resistance	200mΩ max.	100mΩ max.	500m	Ω max.		
Electrical performance	Insulation resistance	100MΩ min. 250V DC	100MΩ min. 100V DC	100MΩ min. 250V DC	100MΩ min. 100V DC		
	Voltage proof	250V AC for 1minute	100V AC for 1 minute	250V AC for 1minute	100V AC for 1minute		
Mechanical	Terminal strength	3N for 1minute	5N for 1minute	-	-		
performance	Actuator strength	20N	10N	20N	10N		
	Cold	-40℃ 500h					
Environmental performance	Dry heat	85°C 500h					
	Damp heat	60°C, 90 to 95%RH 500h					
Opera	ation force	0.7±0.3N	0.7N max.	1N max.	0.7N max.		
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Note

• Indicates applicability to all products in the series.

Example of Reflow Soldering Condition

- 1. Heating method: Double heating method with infrared heater.
 2. Temperature measurement: Thermocouple ϕ 0.1 to 0.2 CA (K) or CC (T) at soldering portion (copper foil surface).
 A heat resisting tape should be used for fixed measurement.
- 3. Temperature profile



Series (Reflow type)	A (℃) 3s max.	B (℃)	C (s)	D (°C)	E (°C)	F(s)
SPPB	250		40			
SPVE						
SPVL						
SPVM						
SPVN	1					
SPVR	260	230	40	180	150	120
SPVS			40			
SPVT						
SSCM						
SSCQ						
SPVQC	250					

Notes

- 1. The condition mentioned above is the temperature on the mounting surface of a PC board. There are cases where the PC board's temperature greatly differs from that of the switch, surface depending on the PC board's material, size, thickness, etc. The above-stated conditions shall also apply to switch surface temperatures.
- 2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Reference for Hand Soldering

Series	Soldering temperature	Soldering time	
SPVS, SPVN, SPVT, SPVM, SPVR, SPVE, SSCQ, SSCM, SPVL, SSCT, SPVQC	350±5℃	3s max.	
SPVQ1, SPVQ3, SPVQ6, SPVQ7, SPVQ8, SPVQ9, SSCN, SPVQA	300±10℃	3+1/0s	
SPPB (Reflow)	300±5℃	5s max.	
SSCF, SPPB (For Lead, Dip)	350±10℃	3+1/0s	

■ Reference for Dip Soldering

(For PC board terminal types)

	Ite	ms	Dip soldering		
Series	Preheating temperature	Preheating time	Soldering temperature	Duration of immersion	
SSCT, SPVQ1, SPVQ3, SPVQ6, SPVQ7, SPVQ8, SPVQ9, SPVQA	100±10℃	60s max.	260±5℃	5±1s	
SPPW8, SPPB	100 ℃ max. 60s max.		255±5℃	5±1s	
SSCF	-	_	260±5℃	5±1s	